Adaptive Power Supply for DAC

Designed for:

Public Release

Assembly Variant:

001

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2014

Drawn By:

Engineer:

Amol Gadkari

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Not in version control

SVN Rev:

TIDA-00231

Number:

Rev:

E1

http://www.ti.com

http://www.ti.com/support
Isolated power supply and Signal Isolation

Isolated from IO controller

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Fiducials

FID1  FID3  FID4

Mounting holes

H2
H1
NY PMS 440 0025 PH  NY PMS 440 0025 PH

PCB Number: TIDA-00231
PCB Rev: E1

LOGO
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ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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